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Patent

FEB 13 2006

Customer No.: 31561  
Docket No.: 10544-US-PA  
Application No.: 10/709,179

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Applicant : Chang et al.

Application No. : 10/709,179

Filed : April 19, 2004

For : STACK-TYPE MULTI-CHIP PACKAGE AND METHOD  
OF FABRICATING BUMPS ON THE BACKSIDE OF A  
CHIP

Art Unit : 2814

Examiner : HA, NATHAN W.

NOTICE OF APPEAL FROM THE EXAMINER TO THE BOARD OF PATENT  
APPEALS AND INTERFERENCES

U.S. Patent and Trademark Office  
Commissioner for Patents  
Customer Window, Mail Stop AF  
Randolph Building, 401 Dulany Street  
Alexandria, VA 22314

Applicants hereby **appeal** to the Board of Patent Appeals and Interferences from  
the last decision of the examiner

- ☒ The fee for this Notice of Appeal is (37 CFR 1.17(b)) \$500.00.  
☒ 1 month extension of time is requested. The time extension fee is  
\$ 120.00.

Please charge the amount of \$620.00 to account No. 50-2620 (Order No.:  
10544-US-PA)

I am the

- ☐ Applicant/inventor  
☐ Assignee of record of the entire interest. Statement under 37 CFR  
3.73b is enclosed.  
☒ Attorney or agent of record  
☐ Attorney or agent acting under 37 CFR 1.34(a).  
Registration number if acting under 37 CDR 1.34(a).\_\_\_\_\_.

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02 FC:1401 500.00 DA

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Patent

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Docket No.: 10544-US-PA  
Application No.: 10/709,179

Respectfully Submitted,  
JIANQ CHYUN Intellectual Property Office

Date: February 13, 2006

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